1206 Package Chip LED

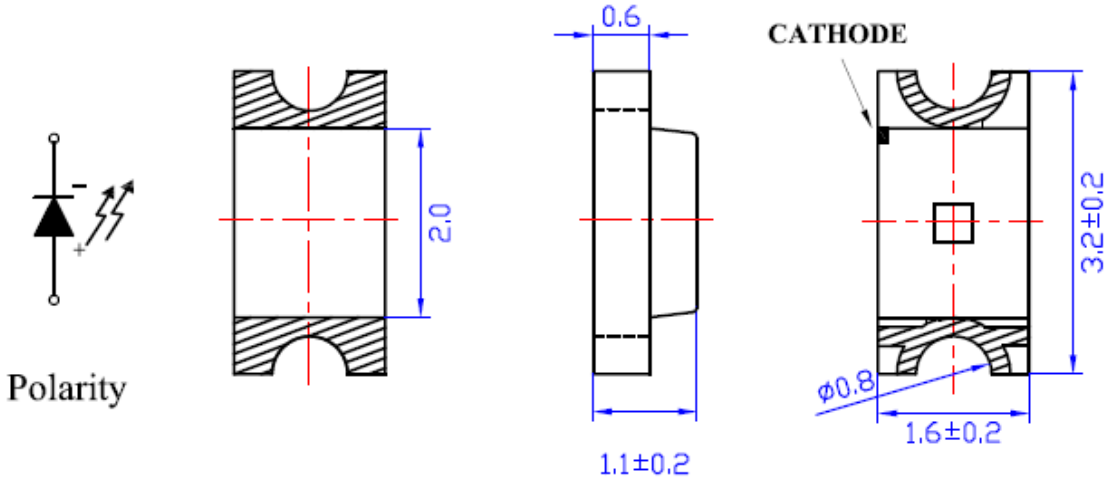
MODEL NO : EC04 – 1206TGC/F



Features

- Package in 8mm tape on 7″ diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS complaint version.

Package Dimensions



Part No.	Chip		Lens Color
	Material	Emitted color	
EC04-1206TGC/F	GaN	Green	Water Clear

Note:

1. All dimensions are in millimeters.
2. Tolerance is ±0.1mm unless otherwise noted.

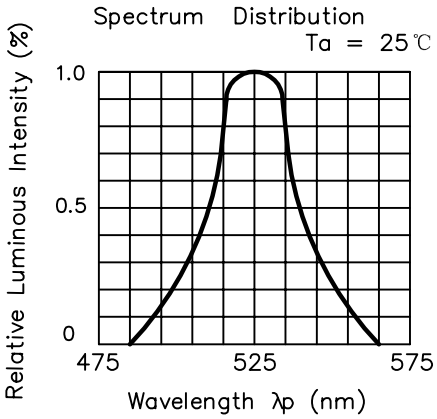
Absolute maximum Ratings (Ta = 25℃)

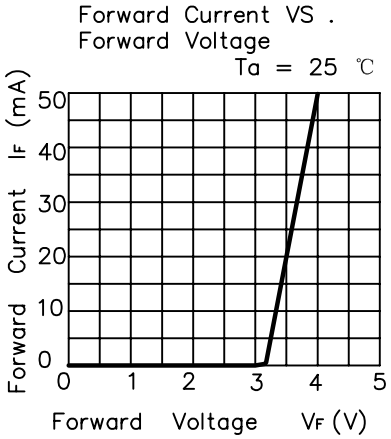
Parameter	Symbol	Max	Unit
Forward current	I_F	30	mA
Reverse voltage	V_R	5	V
Power dissipation	Pd	150	mW
Peak forward current	IFP	100	mA
Operating temperature	Topr	-40℃ to +85℃	
Storage temperature	Tstg	-40℃ to +90℃	
Soldering temperature	Tsol	260℃ for 5 Seconds	

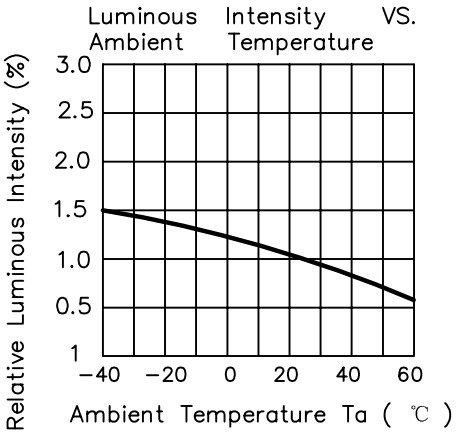
Electro / Optical Characteristics (Ta = 25℃)

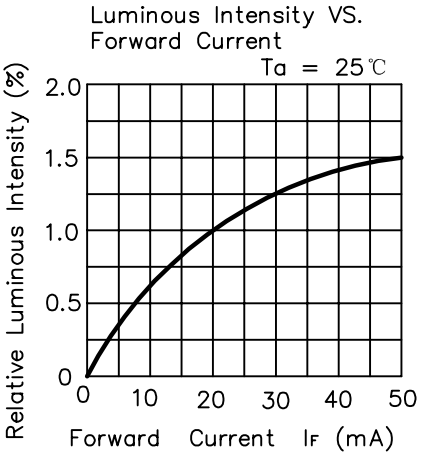
Parameter	Symbol	Condition	Min	Tpy	Max	Unit
Luminous Intensity	Iv	IF = 20mA	63.0	190.0	----	mcd
Forward Voltage	V_F		----	3.5	4.0	V
Reverse Current	I_R	V_R = 5V	----	----	10	μA
View Angle	2θ 1/2	IF = 20mA	----	120	----	deg
Peak Wavelength	λp		----	525	----	nm
Spectral Bandwidth	Δλ		----	36	----	nm
Dominant Wavelength	λd		515	----	525	nm

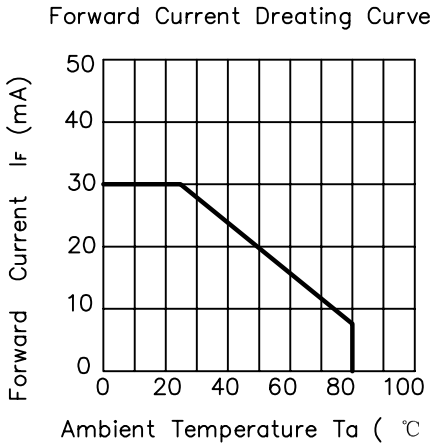
Typical Electro-Optical Dharacteristics Curves

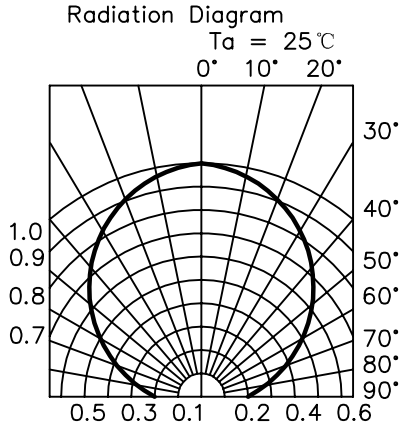










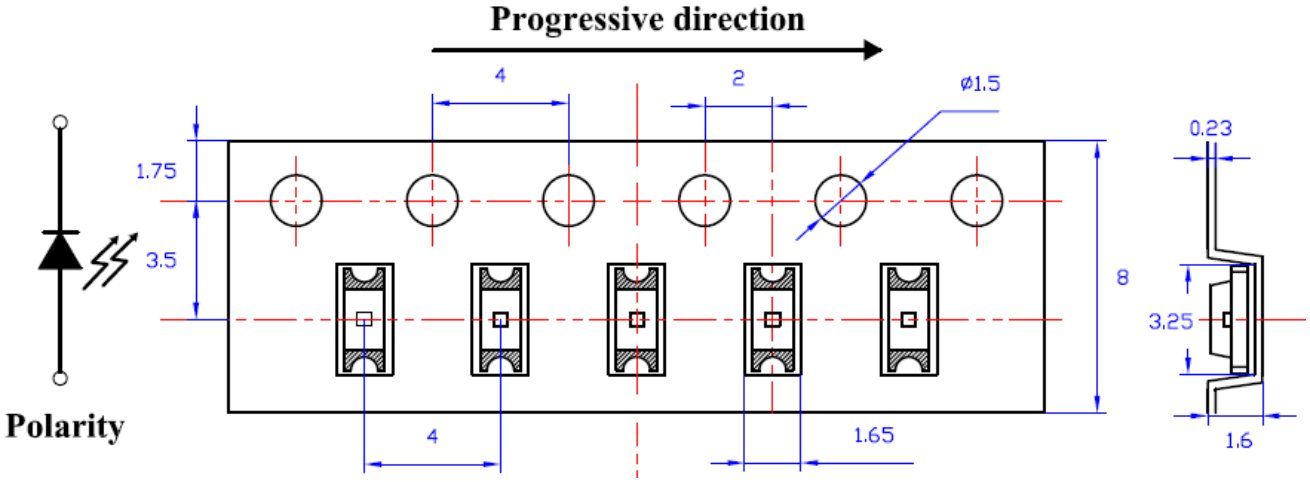


Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.
Confidence level 90%
LTPD 10%

NO.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp.:260℃±5℃ Min 5 sec	6 Min	20 PCS	0/1
2	Temperature Cycle	H:+85℃~ +25℃ 60min 20min L : -35℃~ +25℃ 60min 20min	5Cycles	20 PCS	0/1
3	Thermal Shock	H : +85±5℃ 20min L : -35±5℃ 20min	10Cycles	20 PCS	0/1
4	High Temperature Storage	Temp. : +85℃±5℃	1000 Hrs	20 PCS	0/1
5	Low Temperature Storage	Temp. : -35℃±5℃	1000 Hrs	20 PCS	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs	20 PCS	0/1
7	High Temperature / High Humidity	+65℃±5℃ / 90%-95%RH	240 Hrs	20 PCS	0/1

Carrier Tape Ddimensions : Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned are ±0.1 ,Unit = mn.

Explanation ：

1. **Over-current-proof**
   Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change .

2. Storage:

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package , the LEDs should be kept at 30℃ or less and 90%RH or less.

2.3 After opening the package , the LEDs should be kept at 30℃ or less and 60%RH or less.

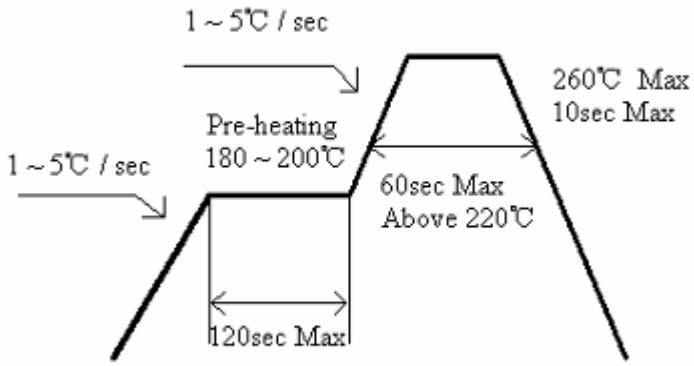
2.4 The LEDs should be used within 168 hours after opening the package.

3 .Soldering Iron

Each terminal is to go to the tip of soldering temperature less than 350℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals , and do soldering of each terminal , Be careful because the damage of the product is often started at the time of the hand solder.

4. Soldering Condition

4.1 Pb-free solder temperature profile.



4.2 Reflow soldering should not be done more than two times.

4.3 When soldering , do not prt stress on the LEDs during heating .

4.4 After soldering , do not warp the circuit board .

5. Repairing

Repair should not be done after the LEDs have been soldered . When repairing is unavoidable , a double-head soldering iron should be used (as below figure) . It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing .